

Surface Mount Standard Recovery Power Rectifier

SMA Power Surface Mount Package

MRA4003T3G Series, NRVA4003T3G Series

Features construction with glass passivation. Ideally suited for surface mounted automotive applications.

Features

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Stable, High Temperature, Glass Passivated Junction
- NRVA Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant*

Mechanical Characteristics

- Case: Molded Epoxy
 Epoxy meets UL 94 V-0 @ 0.125 in
- Weight: 70 mg (Approximately)
- Finish: All External Surfaces are Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 seconds in Solder Bath
- Polarity: Band in Plastic Body Indicates Cathode Lead
- Marking: MRA4003T3G = R13

MRA4004T3G = R14

MRA4005T1G = R15

MRA4005T3G = R15

MRA4006T3G = R16

MRA4000T3G = R10MRA4007T3G = R17

NRVA4003T3G = R13

NRVA4003T3G = R13NRVA4004T3G = R14

NRVA4005T3G = R15

NRVA4006T3G = R16

NRVA4007T3G = R17

- ESD Rating:
 - Human Body Model 3A
 - · Machine Model C

STANDARD RECOVERY RECTIFIERS 1.0 AMPERES 300-1000 VOLTS



SMA CASE 403D

MARKING DIAGRAM



R1x = Specific Device Code

= Wafer Source

A = Assembly Location

= Year

WW = Work Week

= Pb–Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the ordering information section on page 4 of this data sheet.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MRA4003T3G Series, NRVA4003T3G Series

MAXIMUM RATINGS

		Value					
Rating	Symbol	MRA4003	MRA4004/ NRVA4004	MRA4005/ NRVA4005	MRA4006/ NRVA4006	MRA4007/ NRVA4007	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	300	400	600	800	1000	Volts
Avg. Rectified Forward Current (At Rated V _R , T _L = 150°C)	I _O	1				Amp	
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 20 kHz, $T_L = 150$ °C)	I _{FRM}	2			Amps		
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I _{FSM}	30			Amps		
Junction Operating Temperature Range	TJ	-55 to 150			°C		
Storage Temperature Range	T _{stg}	-55 to 175			°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead (Note 1) Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JL} \ R_{ heta JA}$	16.2 88.3	°C/W

ELECTRICAL CHARACTERISTICS

		Value		
Characteristic	Symbol	T _J = 25°C	T _J = 100°C	Unit
Maximum Instantaneous Forward Voltage (Note 3) (I _F = 1 A) (I _F = 2 A)	V _F	1.1 1.18	1.04 1.12	Volts
Maximum Instantaneous Reverse Current (at rated DC voltage)	I _R	10	50	μΑ

- 1. Minimum Pad Size
- 2. 1 inch Pad Size
- 3. Pulse Test: Pulse Width \leq 250 $\mu s,$ Duty Cycle \leq 2%.

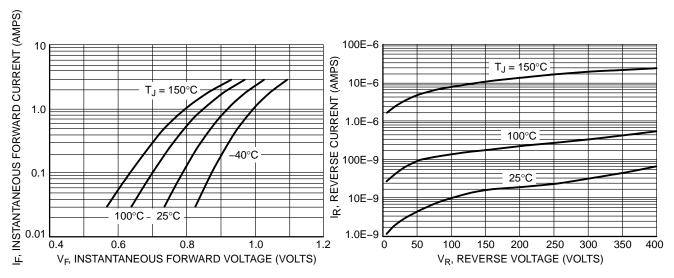
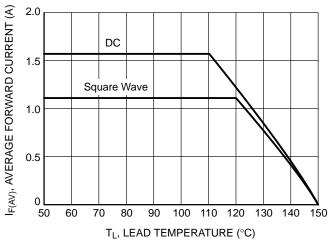


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

MRA4003T3G Series, NRVA4003T3G Series



1.8 P_{FO}, AVERAGE POWER DISSIPATION (WATTS) dc 1.6 1.4 Square Wave 1.2 1.0 0.8 0.6 0.4 0.2 0 2.0 0.5 1.0 1.5 0 I_O, AVERAGE FORWARD CURRENT (AMPS)

Figure 3. Current Derating

Figure 4. Forward Power Dissipation per Leg

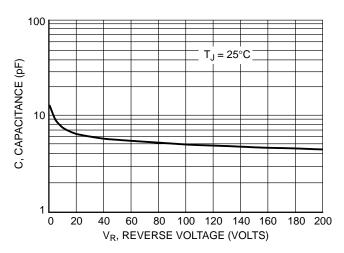


Figure 5. Capacitance

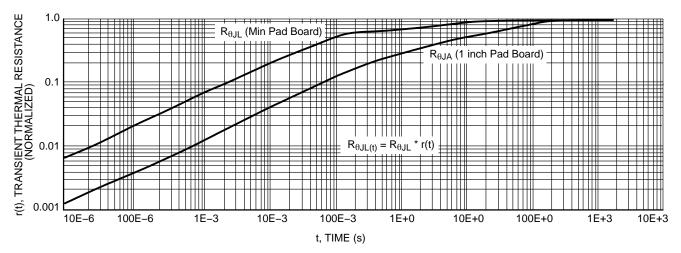


Figure 6. Thermal Response

MRA4003T3G Series, NRVA4003T3G Series

ORDERING INFORMATION

Device	Package	Shipping†
MRA4003T3G		5 000 /T 0 B 1
MRA4004T3G		5,000 / Tape & Reel
MRA4005T1G		1,500 / Tape & Reel
MRA4005T3G		
MRA4006T3G	SMA (Pb-Free)	5,000 / Tape & Reel
MRA4007T3G		
NRVA4003T3G*		
NRVA4004T3G*		
NRVA4005T3G*		5,000 / Tape & Reel
NRVA4006T3G*		
NRVA4007T3G*		

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}NRVA Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS







STYLE 1 STYLE 2

SCALE 1:1

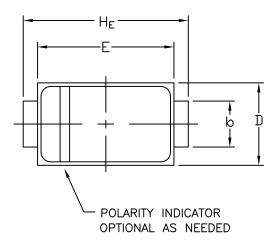


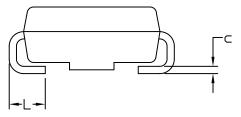
DATE 22 OCT 2021

NOTES:

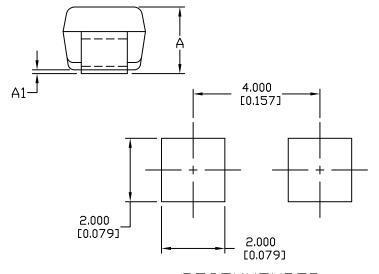
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCHES
- 3. DIMENSION & SHALL BE MEASURED WITHIN DIMENSION L.

	MILLIMETERS				INCHES		
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.	
Α	1.97	2.10	2.20	0.078	0.083	0.087	
A1	0.05	0.10	0.20	0.002	0.004	0.008	
b	1.27	1.45	1.63	0.050	0.057	0.064	
С	0.15	0.28	0.41	0.006	0.011	0.016	
D	2.29	2.60	2.92	0.090	0.103	0.115	
Ε	4.06	4.32	4.57	0.160	0.170	0.180	
HE	4.83	5.21	5.59	0.190	0.205	0.220	
L	0.76	1.14	1.52	0.030	0.045	0.060	



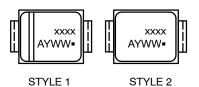


STYLE 1: STYLE 2: PIN 1. CATHODE (POLARITY BAND) NO POLARITY 2. ANODE



RECOMMENDED MOUNTING FOOTPRINT

GENERIC MARKING DIAGRAM*



xxxx = Specific Device Code
A = Assembly Location
Y = Year
Work Work

WW = Work Week= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON04079D	ON04079D Electronic versions are uncontrolled except when accessed directly from the Docum Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in re		
DESCRIPTION:	SMA		PAGE 1 OF 1	

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales